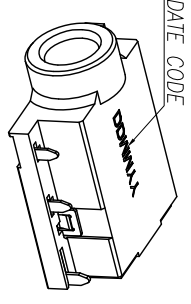


REV.	ECN NO.	OR DESCRIPTION	REVISED	DATE
B	ADD	MYLAR	Steven-hu	2010.04.12
C	ECN NO:C11049-1	Modify Plating specification	BILLY	2011.06.23
D	ECN NO:C140074	Modify Layout	ZLS	2014.7.28



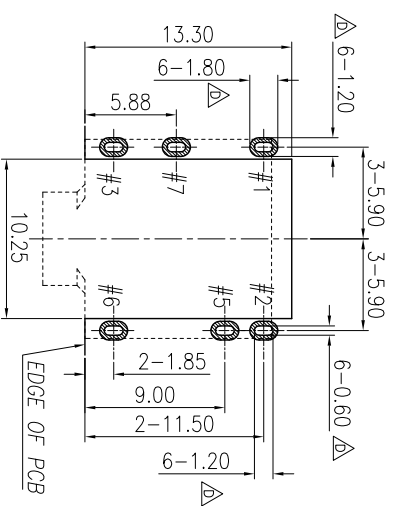
SPECIFICATIONS:

- ELECTRICAL CHARACTERISTICS:
 - RATING: 36V AC, 1A DC.
 - CONTACT RESISTANCE: 50m Ω MAX.
 - DIELECTRIC WITHSTANDING VOLTAGE: 500V AC FOR ONE MINUTE.
 - INSULATION RESISTANCE: 100MΩ MIN. MEASURED BY 500 VDC.
- MECHANICAL CHARACTERISTICS:
 - INSERTION FORCE : 0.4~3.0 KGF
 - WITHDRAWAL FORCE : 0.3~2.0 KGF
 - LIFE TEST: 5,000 CYCLES MIN.
 - OTHER GENERAL SPEC. TO REFER "2SJ2285 SERIES SPEC."
 - TO CONFORM TO THE SINGATRON HAZARDOUS SUBSTANCE FREE SPEC.
 - HALOGEN FREE PRODUCT IDENTIFICATION MARK ON JACK: ◎
 - HALOGEN FREE PRODUCT IDENTIFICATION LABEL ON PACKAGING:
 - FOR REFLOW SOLDERING LEAD-FREE PROCESS.
 - PACKAGING:TAP&REEL.

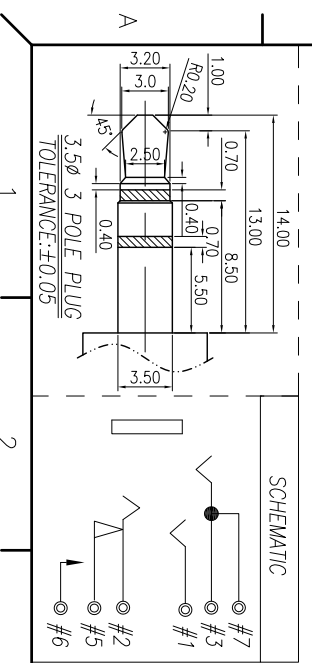


"TABLE"

P/N	BODY COLOR
2SJ2285-012402	GREEN/3415C
2SJ2285-012452	RED(703C)



RECOMMENDED P.C.B. LAYOUT T=1.20
TOP VIEW (TOLERANCE: ±0.05)



NO	DESCRIPTION	QTY	MATERIAL	PLATING & COLOR
H	MYLAR	1	MYLAR 0.075T	
G	SHIELD	1	COPPER ALLOY 0.20T	NI PLATING
F	TRANSFER TERMINAL	1	COPPER ALLOY 0.20T	△ Gold Flash on contact area and Solder tail/call over Nickel Plated
E	MAKE TERMINAL	1	COPPER ALLOY 0.20T	GOLD FLASH
D	RING	1	COPPER ALLOY 0.20T	△ Gold Flash on contact area and Solder tail/call over Nickel Plated
C	TIP	1	COPPER ALLOY 0.25T	
B	EARTH	1	COPPER ALLOY 0.20T	GOLD FLASH
A	BODY	1	HIGH TEMP.THERMOPLASTIC UL 94V-0	SEE "TABLE"
NO	DESCRIPTION	QTY	MATERIAL	PLATING & COLOR



Singatron Enterprise Co., Ltd.
信亨企業股份有限公司

UNLESS OTHERWISE SPECIFIED TOLERANCES

DECIMALS: ANGLES:
X :±0.5 X :±2°
X.X :±0.3 X.X :±1°
X.XX :±0.2

TITLE: 3.5Ø PHONE JACK

DWN ZLS 14/8/19 PART NO. 2SJ2285-0124X2

CHKD BILLY 14/8/19 SCALE 3:1 UNIT: mm SHEET: 10F1 REV: D

APVD ZLS 14/8/19 SIZE: A3 SHEET: 10F1 REV: D

CUSTOMER COPY